



SPP9435W P-Channel Enhancement Mode MOSFET

DESCRIPTION

The SPP9435W is the P-Channel logic enhancement mode power field effect transistors are produced using high cell density, DMOS trench technology.

This high density process is especially tailored to minimize on-state resistance.

These devices are particularly suited for low voltage application, notebook computer power management and other battery powered circuits where high-side switching.

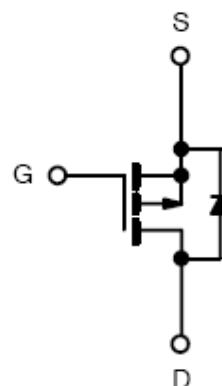
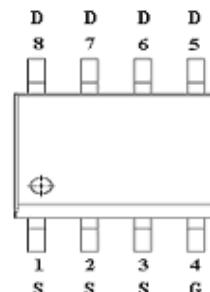
APPLICATIONS

- Power Management in Note book
- Portable Equipment
- Battery Powered System
- DC/DC Converter
- Load Switch
- DSC
- LCD Display inverter

FEATURES

- ◆ -30V/-7.2A, $R_{DS(ON)} = 65m\Omega @ V_{GS} = -10V$
- ◆ -30V/-5.0A, $R_{DS(ON)} = 90m\Omega @ V_{GS} = -4.5V$
- ◆ Super high density cell design for extremely low $R_{DS(ON)}$
- ◆ Exceptional on-resistance and maximum DC current capability
- ◆ SOP – 8P package design

PIN CONFIGURATION(SOP – 8P)



PART MARKING



A : Lot Code
B : Date Code



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PIN DESCRIPTION

Pin	Symbol	Description
1	S	Source
2	S	Source
3	S	Source
4	G	Gate
5	D	Drain
6	D	Drain
7	D	Drain
8	D	Drain

ORDERING INFORMATION

Part Number	Package	Part Marking
SPP9435WS8RG	SOP- 8P	SPP9435W
SPP9435WS8RGB	SOP- 8P	SPP9435W

※ SPP9435WS8RG 13" Tape Reel ; Pb – Free

※ SPP9435WS8RGB 13" Tape Reel ; Pb – Free ; Halogen – Free

ABSOLUTE MAXIMUM RATINGS

(TA=25°C Unless otherwise noted)

Parameter	Symbol	Typical	Unit
Drain-Source Voltage	V _{DSS}	-30	V
Gate –Source Voltage	V _{GSS}	±20	V
Continuous Drain Current(T _J =150°C)	T _A =25°C	-7.2	A
	T _A =70°C		
Pulsed Drain Current	I _{DM}	-25	A
Continuous Source Current(Diode Conduction)	I _S	-2.3	A
Power Dissipation	T _A =25°C	2.8	W
	T _A =70°C		
Operating Junction Temperature	T _J	-55/150	°C
Storage Temperature Range	T _{STG}	-55/150	°C
Thermal Resistance-Junction to Ambient	R _{θJA}	70	°C/W



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ELECTRICAL CHARACTERISTICS

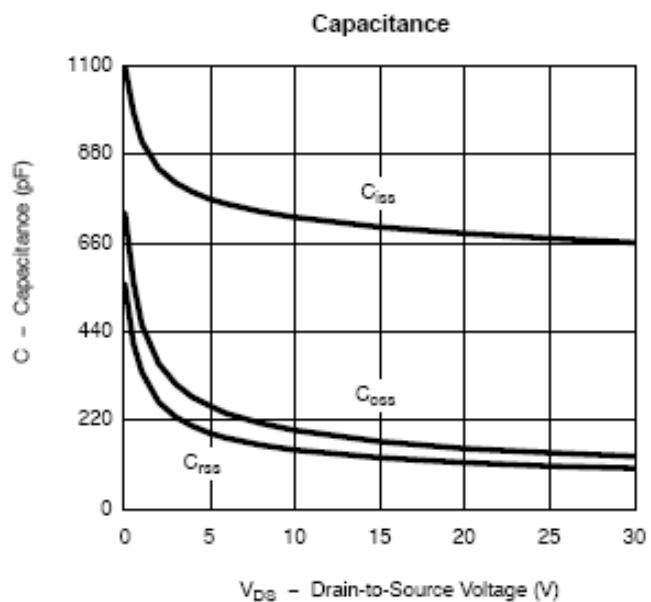
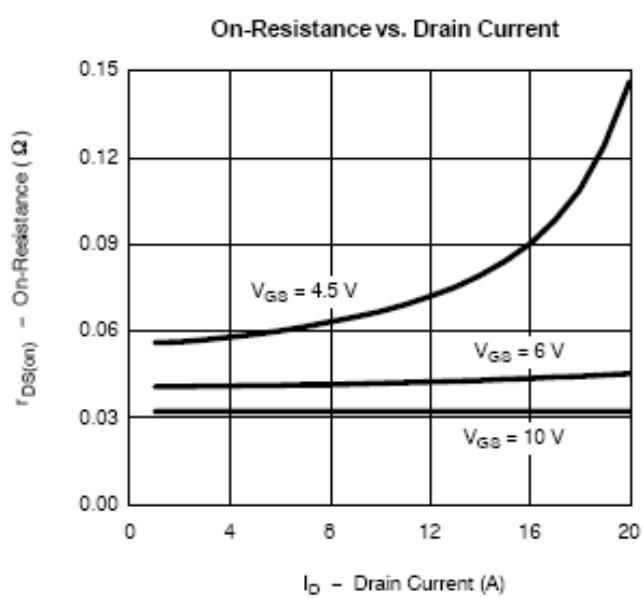
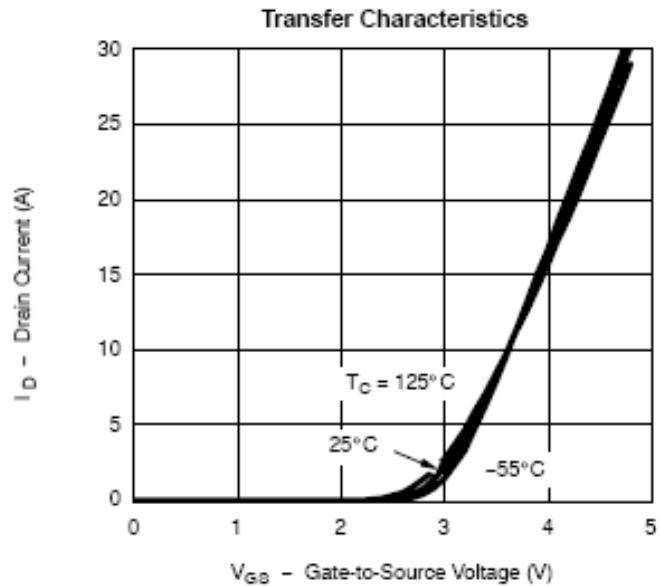
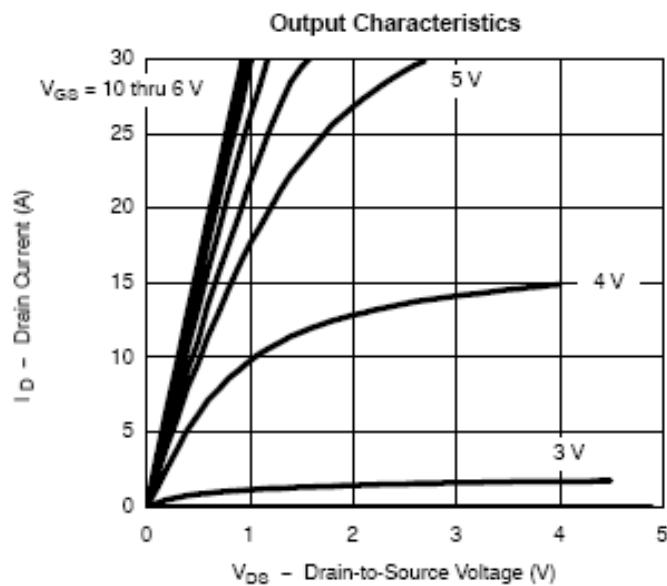
(TA=25°C Unless otherwise noted)

Parameter	Symbol	Conditions	Min.	Typ	Max.	Unit
Static						
Drain-Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} =0V, ID=-250uA	-30			V
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} , ID=-250uA	-0.8		-3.0	
Gate Leakage Current	I _{GSS}	V _{DS} =0V, V _{GS} =±20V			±100	nA
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =-24V, V _{GS} =0V			-1	
		V _{DS} =-24V, V _{GS} =0V T _J =55°C			-5	uA
On-State Drain Current	I _{D(on)}	V _{DS} = -5V, V _{GS} =-4.5V	-10			A
Drain-Source On-Resistance	R _{DSS(on)}	V _{GS} =-10V, ID=-6.5A		0.055	0.070	
		V _{GS} =-4.5V, ID=-5.0A		0.070	0.090	Ω
Forward Transconductance	g _{fs}	V _{DS} =-15V, ID=-5.7A		13		S
Diode Forward Voltage	V _{SD}	I _S =-1.3A, V _{GS} =0V		-0.87	-1.2	V
Dynamic						
Total Gate Charge	Q _g	V _{DS} =-15V, V _{GS} =-10V ID= -3.5A		10	18	
Gate-Source Charge	Q _{gs}			1.6		nC
Gate-Drain Charge	Q _{gd}			3.0		
Input Capacitance	C _{iss}	V _{DS} =-15V, V _{GS} =0V f=1MHz		450		
Output Capacitance	C _{oss}			95		pF
Reverse Transfer Capacitance	C _{rss}			55		
Turn-On Time	t _{d(on)}	V _{DD} =-15V, R _L =15Ω ID=-1.0A, V _{GEN} =-10V R _G =6Ω		8	18	
	t _r			8	18	nS
Turn-Off Time	t _{d(off)}			25	50	
	t _f			25	35	



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TYPICAL CHARACTERISTICS

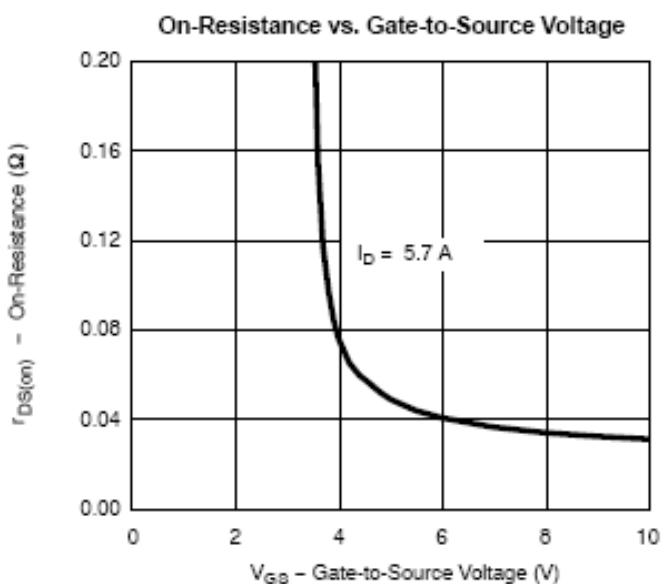
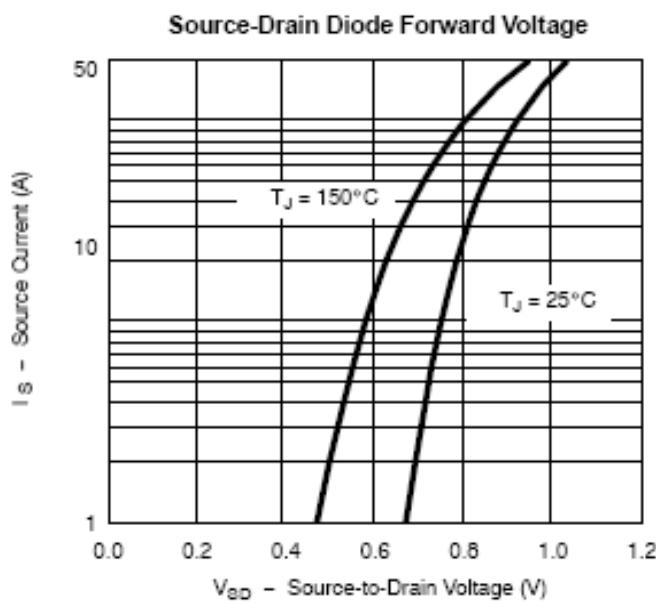
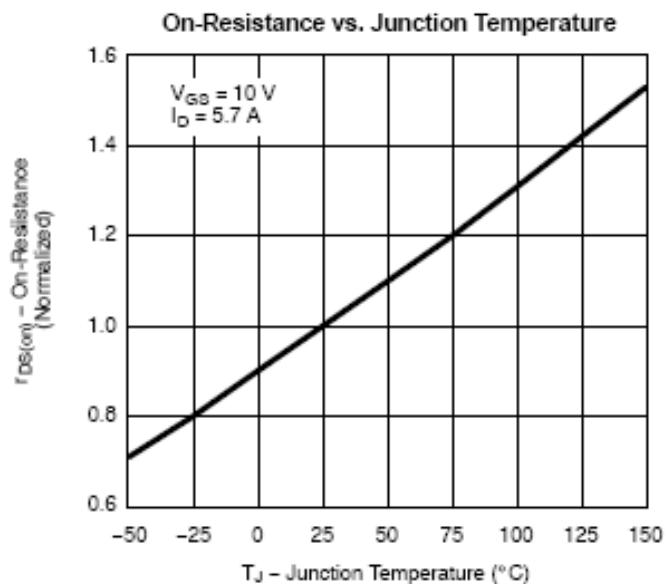
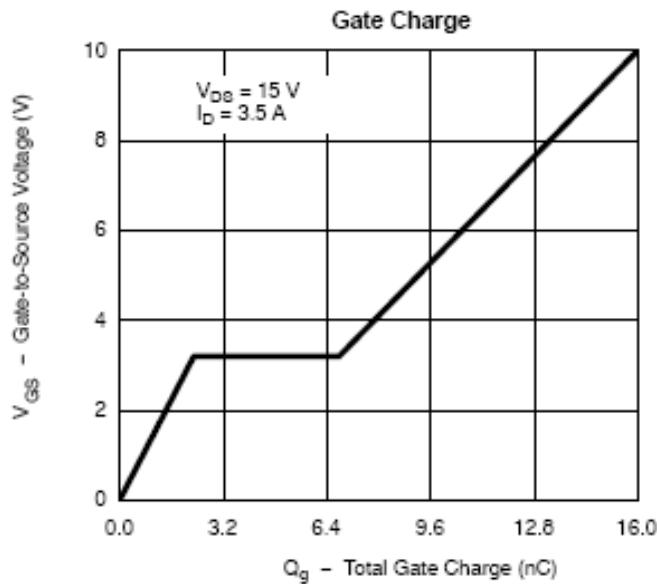




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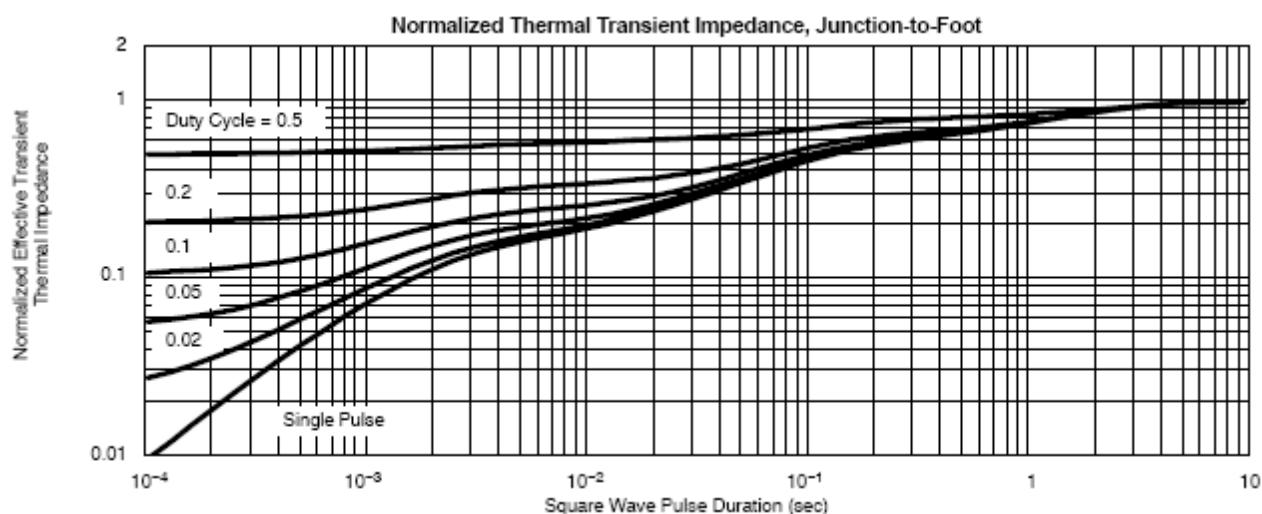
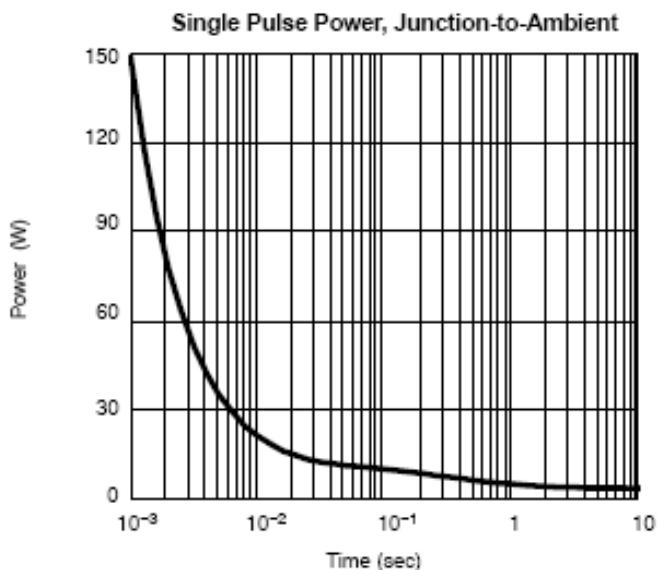
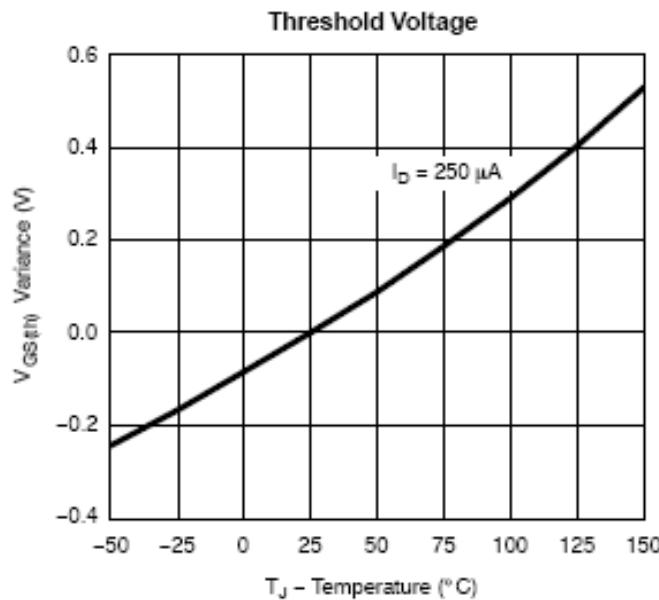
TYPICAL CHARACTERISTICS





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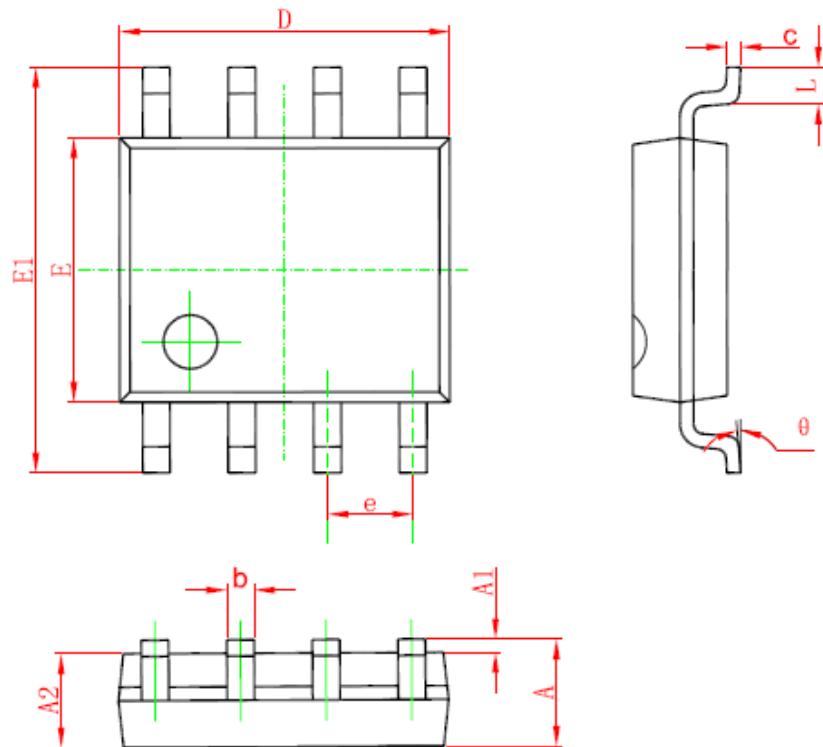




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SOP- 8 PACKAGE OUTLINE



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	1.350	1.750	0.053	0.069
A1	0.100	0.250	0.004	0.010
A2	1.350	1.550	0.053	0.061
b	0.330	0.510	0.013	0.020
c	0.170	0.250	0.006	0.010
D	4.700	5.100	0.185	0.200
E	3.800	4.000	0.150	0.157
E1	5.800	6.200	0.228	0.244
e	1.270(BSC)		0.050(BSC)	
L	0.400	1.270	0.016	0.050
θ	0°	8°	0°	8°



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